

PMEG100T10ELR-Q

100 V, 1 A low leakage current Trench Schottky barrier rectifier

19 July 2024

Product data sheet

1. General description

Trench Schottky barrier rectifier encapsulated in a CFP3 (SOD123W) small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Low forward voltage
- Low Q_{rr} and low I_{RM}
- · Low leakage current
- · High power capability due to clip-bonding technology
- Small and flat lead SMD power plastic package
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- High efficiency DC-to-DC conversion
- · Automotive LED lighting
- · Switch mode power supply
- Freewheeling applications
- · Reverse polarity protection
- OR-ing

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; $T_{sp} \le$ 166 °C		-	-	1	А
V_R	reverse voltage	T _j = 25 °C		-	-	100	V
V _F	forward voltage	I _F = 1 A; pulsed; T _j = 25 °C	[1]	-	670	750	mV
I _R	reverse current	V _R = 100 V; pulsed; T _j = 25 °C	[1]	-	0.1	0.9	μΑ
		V _R = 100 V; pulsed; T _j = 125 °C	[1]	-	0.18	1	mA

^[1] Very short pulse, in order to maintain a stable junction temperature.



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]		к.[К.]- А
2	А	anode	CFP3 (SOD123W)	sym001

^[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG100T10ELR-Q	CFP3	plastic, surface mounted package; 2 terminals; 2.6 mm x 1.7 mm x 1 mm body	SOD123W

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG100T10ELR-Q	LA

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	T _j = 25 °C		-	100	V
I _F	forward current	δ = 1; T _{sp} ≤ 163 °C		-	1.4	А
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} ≤ 166 °C		-	1	Α
I _{FSM}	non-repetitive peak forward current	$t_p = 8.3 \text{ ms}$; half sine wave; $T_{j(init)} = 25 \text{ °C}$		-	40	A
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	0.68	W
			[2]	-	1.15	W
T _j	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

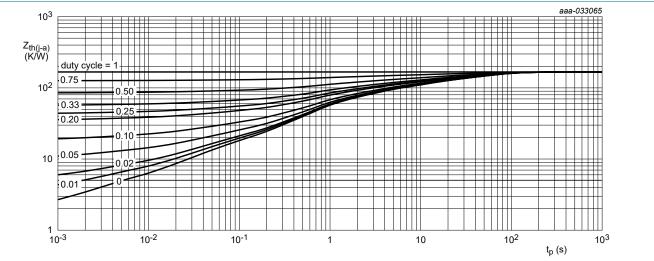
^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

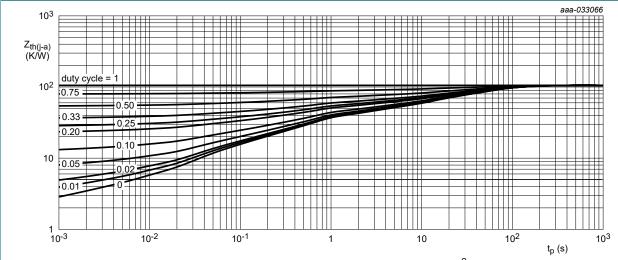
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	[1] [2]	-	-	220	K/W
junction to a	junction to ambient		[1] [3]	-	-	130	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[4]	-	-	18	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Soldering point of cathode tab.



FR4 PCB, single-sided copper, tin-plated and standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, single-sided copper, tin-plated and mounting pad for cathode 1 cm²

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

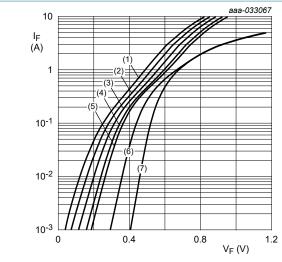
10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	I _R = 1 mA; T _j = 25 °C	[1]	100	-	-	V
V_{F}	forward voltage	I _F = 0.1 A; pulsed; T _j = 25 °C	[1]	-	440	510	mV
		I _F = 0.5 A; pulsed; T _j = 25 °C	[1]	-	560	630	mV
		I _F = 1 A; pulsed; T _j = 25 °C	[1]	-	670	750	mV
		I _F = 1 A; pulsed; T _j = -40 °C	[1]	-	680	750	mV
		I _F = 1 A; pulsed; T _j = 125 °C	[1]	-	565	630	mV
		I _F = 1 A; pulsed; T _j = 150 °C	[1]	-	525	600	mV
I _R	reverse current	V _R = 60 V; pulsed; T _j = 25 °C	[1]	-	0.04	0.3	μA
		V_R = 100 V; pulsed; T_j = 25 °C	[1]	-	0.1	0.9	μΑ
		V _R = 100 V; pulsed; T _j = 125 °C	[1]	-	0.18	1	mA
		V _R = 100 V; pulsed; T _j = 150 °C	[1]	-	0.7	3.5	mA
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C		-	125	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C		-	36	-	pF
t _{rr}	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$		-	4	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 200 \text{ A/}\mu\text{s}; I_F = 6 \text{ A}; V_R = 26 \text{ V};$ $T_j = 25 \text{ °C}$		-	11.5	-	ns
I _{RM}	peak reverse recovery current			-	1.2	-	Α
Q _{rr}	reverse recovery charge			-	8	-	nC
V_{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 \text{ °C}$		-	560	-	mV

^[1] Very short pulse, in order to maintain a stable junction temperature.

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pulsed condition

(1) Tj = 175 °C

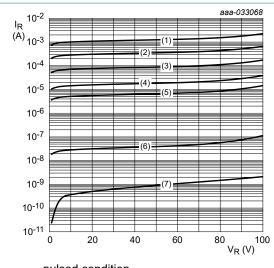
(2) Tj = 150 °C

(3) Tj = 125 °C (4) Tj = 100 °C

(5) Tj = 85 °C (6) Tj = $25 \, ^{\circ}$ C

(7) Tj = -40 °C

Fig. 3. Forward current as a function of forward voltage; typical values



pulsed condition

(1) $T_i = 175 \, ^{\circ}C$

(2) T_{i} = 150 °C

 $(3) T_i = 125 °C$

 $(4) T_i = 100 °C$

 $(5) T_i = 85 ^{\circ}C$ (6) $T_i = 25 \,^{\circ}\text{C}$

(7) $T_i = -40$ °C

Fig. 4. Reverse current as a function of reverse voltage; typical values

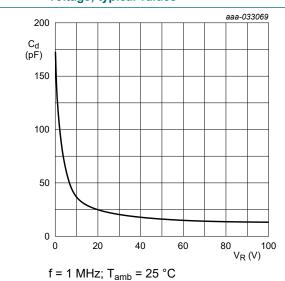
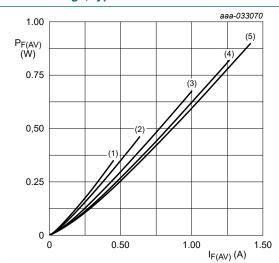


Fig. 5. Diode capacitance as a function of reverse voltage; typical values



T_i = 100 °C

 $(1) \delta = 0.1$

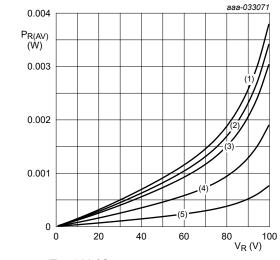
(2) $\delta = 0.2$

 $(3) \delta = 0.5$

 $(4) \delta = 0.8$

(5) $\delta = 1$; DC

Average forward power dissipation as a Fig. 6. function of average forward current; typical values



 $T_j = 100 \,^{\circ}C$

 $(1) \delta = 1; DC$

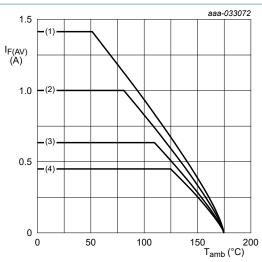
 $(2) \delta = 0.9$

 $(3) \delta = 0.8$

 $(4) \delta = 0.5$

 $(5) \delta = 0.2$

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T_i = 175 °C

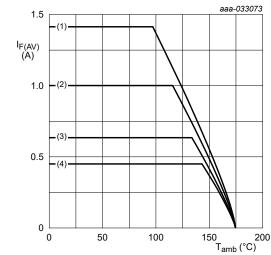
 $(1) \delta = 1; DC$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

 $T_{i} = 175 \,^{\circ}\text{C}$

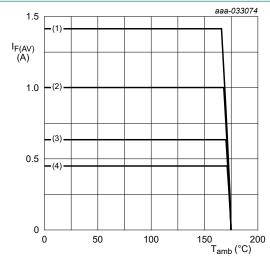
 $(1) \delta = 1; DC$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

 $(4) \delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



Tj = 175 °C

(1) $\delta = 1$; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

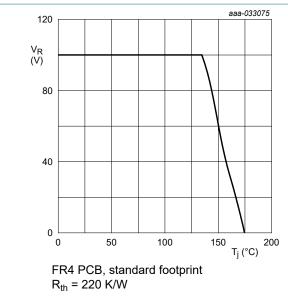
Fig. 10. Average forward current as a function of solder point temperature; typical values

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100 V, 1 A low leakage current Trench Schottky barrier rectifier

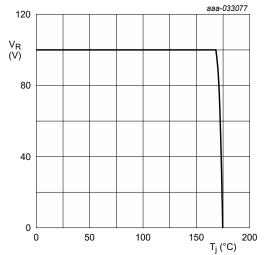
120



V_R (V) 80 40 50 100 150 FR4 PCB, mounting pad for cathode 1 cm² $R_{th} = 130 \text{ K/W}$

of junction temperature; typical values

Fig. 11. Derated maximum reverse voltage as a function | Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values



Soldering point of cathode tab $R_{th} = 18 \text{ K/W}$

Fig. 13. Derated maximum reverse voltage as a function of junction temperature; typical values

11. Test information

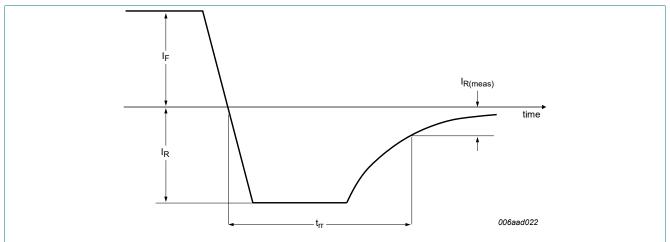


Fig. 14. Reverse recovery definition; step recovery

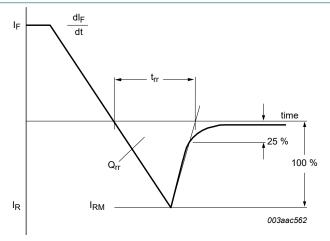


Fig. 15. Reverse recovery definition; ramp recovery

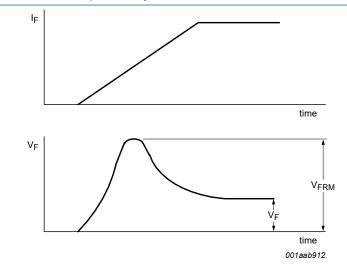
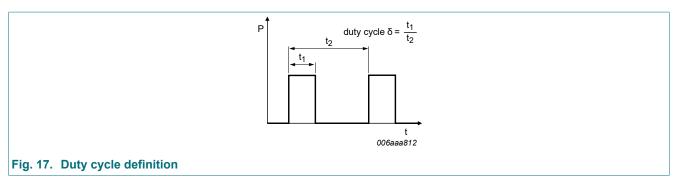


Fig. 16. Forward recovery definition



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current

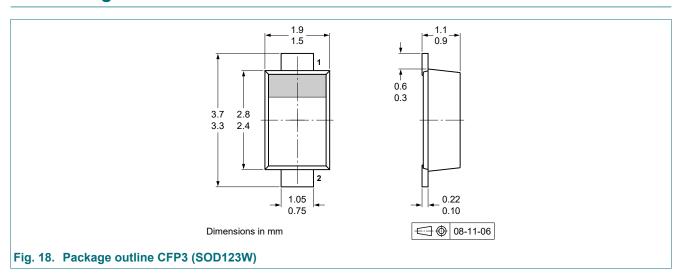
 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$

with I_{RMS} defined as RMS current.

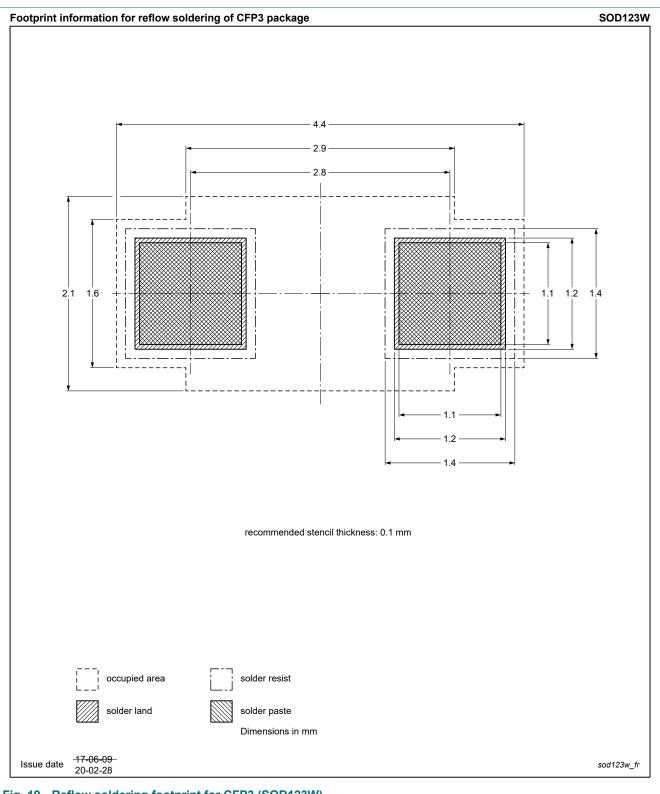
Quality information

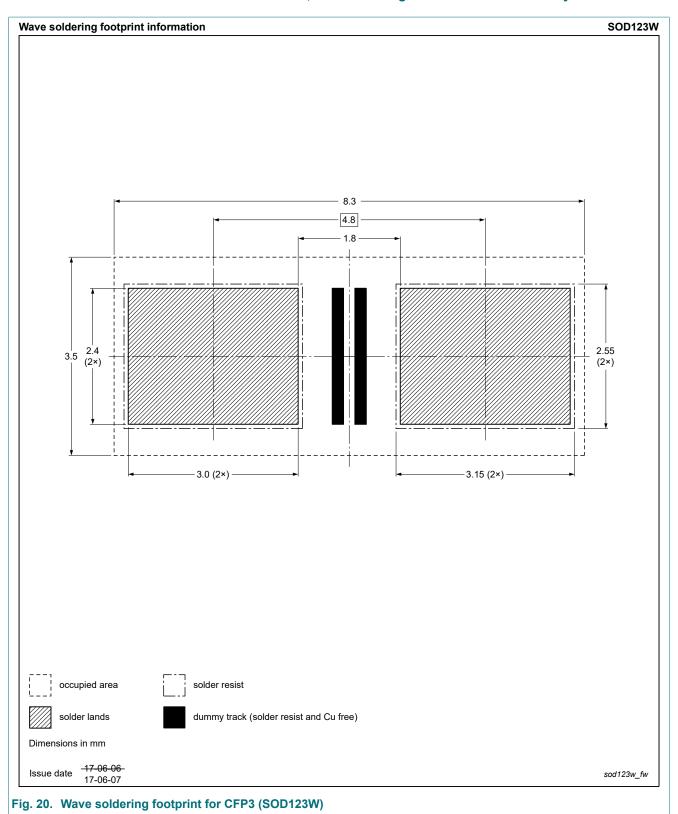
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline



13. Soldering





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14. Revision history

Table 8. Revision history

Table of Revision mistory								
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
PMEG100T10ELR-Q v.3	20240719	Product data sheet	-	PMEG100T10ELR-Q v.2				
Modifications:	Characteristic	Characteristics:I _{RM} and Q _{rr} conditions changed						
PMEG100T10ELR-Q v.2	20210712	Product data sheet	-	PMEG100T10ELR-Q v.1				
PMEG100T10ELR-Q v.1	20210519	Product data sheet	-	-				

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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